Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Discontinued at Digi-Key
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	I²C, LINbus, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	37
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f562taedfk-v3

1. Overview

1.1 Outline of Specifications

Table 1.1 lists the specifications in outline, and Table 1.2 lists the functions of products.

Table 1.1 Outline of Specifications (1 / 5)

Classification	Module/Function	Description
CPU	CPU	• Maximum operating frequency: 100MHz • 32-bit RX CPU • Minimum instruction execution time: One instruction per state (cycle of the system clock) • Address space: 4-Gbyte linear • Register set of the CPU • General purpose: Sixteen 32-bit registers • Control: Nine 32-bit registers • Accumulator: One 64-bit register • Basic instructions: 73 • Floating-point instructions: 8 • DSP instructions: 9 • Addressing modes: 10 • Data arrangement • Instructions: Little endian • Data: Selectable as little endian or big endian • On-chip 32-bit multiplier: 32 x 32 → 64 bits • On-chip divider: 32 / 32 → 32 bits • Barrel shifter: 32 bits • Memory-protection unit (MPU)
	FPU	• Single precision (32-bit) floating point • Data types and floating-point exceptions in conformance with the IEEE754 standard
Memory	ROM	• ROM capacity: 256 Kbytes (max.) • Two on-board programming modes • Boot mode (The user MAT is programmable via the SCI) • User program mode • Off-board programming • A PROM programmer can be used to program the user mat.
	RAM	• RAM capacity: 16 Kbytes (max.)
	Data flash	• Data flash capacity: 32 Kbytes (max.) • Supports background operations (BGO)
MCU operating mode		• Single-chip mode
Clock	Clock generation circuit	• One circuit: Main clock oscillator • Internal oscillator: Low-speed on-chip oscillator dedicated to IWDT • Structure of a PLL frequency synthesizer and frequency divider for selectable operating frequency • Oscillation stoppage detection • Independent frequency-division and multiplication settings for the system clock (ICLK) and peripheral module clock (PCLK) • The CPU and system sections such as other bus masters, MTU3, and GPT run in synchronization with the system clock (ICLK): 8 to 100 MHz. • Peripheral modules run in synchronization with the peripheral module clock (PCLK): 8 to 50 MHz
Reset		Pin reset, power-on reset (automatic power-on reset when the power is turned on), voltage-monitoring reset, watchdog timer reset, independent watchdog timer reset, and deep software standby reset
Voltage detection circuit (LVD)		When the voltage on VCC falls below the voltage detection level (Vdet), an internal reset or internal interrupt is generated.
Low power consumption	Low power consumption facilities	• Module stop function • Four low power consumption modes • Sleep mode, all-module clock stop mode, software standby mode, and deep software standby mode

1.2 List of Products

Table 1.3 is a list of products, and Figure 1.1 shows how to read the product part no.

Table 1.3 List of Products (1 / 2)

Group	Part No.	Order Part No.	Package	ROM Capacity	RAM Capacity	Data Flash Capacity	Power Supply Voltage	CAN	Operating Temp. Range
RX62T	R5F562TAADFH	R5F562TAADFH#V3	PLQP0112JA-A	256 Kbytes	16 Kbytes	32 Kbytes	VCC/PLLVCC 4.0 to 5.5 V AVCC/AVCC0 4.0 to 5.5 V	Support-ed	-40 to +85°C (D version)
	R5F562TAADFP	R5F562TAADFP#V3	PLQP0100KB-A						
	R5F562TAADFF	R5F562TAADFF#V3	PLQP0080JA-A						
	R5F562TAGDFF	R5F562TAGDFF#V3	PLQP0080JA-A						
	R5F562TAADFM	R5F562TAADFM#V3	PLQP0064KB-A						
	R5F562TAADFK	R5F562TAADFK#V3	PLQP0064GA-A						
	R5F562T7ADFH	R5F562T7ADFH#V3	PLQP0112JA-A	128 Kbytes	8 Kbytes	8 Kbytes			
	R5F562T7ADFP	R5F562T7ADFP#V3	PLQP0100KB-A						
	R5F562T7ADFF	R5F562T7ADFF#V3	PLQP0080JA-A						
	R5F562T7GDFF	R5F562T7GDFF#V3	PLQP0080JA-A						
	R5F562T7ADFM	R5F562T7ADFM#V3	PLQP0064KB-A						
	R5F562T7ADFK	R5F562T7ADFK#V3	PLQP0064GA-A						
	R5F562T6ADFF	R5F562T6ADFF#V3	PLQP0080JA-A	64 Kbytes	8 Kbytes				
	R5F562T6ADFM	R5F562T6ADFM#V3	PLQP0064KB-A						
	R5F562T6ADFK	R5F562T6ADFK#V3	PLQP0064GA-A						
	R5F562TABDFH	R5F562TABDFH#V3	PLQP0112JA-A	256 Kbytes	16 Kbytes	32 Kbytes	VCC/PLLVCC 2.7 to 3.6 V AVCC/AVCC0 3.0 to 3.6 V or 4.0 to 5.5 V		
	R5F562TABDFP	R5F562TABDFP#V3	PLQP0100KB-A						
	R5F562TABDFF	R5F562TABDFF#V3	PLQP0080JA-A						
	R5F562TABDFM	R5F562TABDFM#V3	PLQP0064KB-A						
	R5F562TABDFK	R5F562TABDFK#V3	PLQP0064GA-A						
	R5F562T7BDFH	R5F562T7BDFH#V3	PLQP0112JA-A	128 Kbytes	8 Kbytes	8 Kbytes			
	R5F562T7BDFP	R5F562T7BDFP#V3	PLQP0100KB-A						
	R5F562T7BDFF	R5F562T7BDFF#V3	PLQP0080JA-A						
	R5F562T7BDFM	R5F562T7BDFM#V3	PLQP0064KB-A						
	R5F562T7BDFK	R5F562T7BDFK#V3	PLQP0064GA-A						
	R5F562T6BDFF	R5F562T6BDFF#V3	PLQP0080JA-A	64 Kbytes	8 Kbytes				
	R5F562T6BDFM	R5F562T6BDFM#V3	PLQP0064KB-A						
	R5F562T6BDFK	R5F562T6BDFK#V3	PLQP0064GA-A						
	R5F562TADDFH	R5F562TADDFH#V3	PLQP0112JA-A	256 Kbytes	16 Kbytes	32 Kbytes	4.0 to 5.5 V	Not Support-ed	
	R5F562TADDFP	R5F562TADDFP#V3	PLQP0100KB-A						
	R5F562TADDFF	R5F562TADDFF#V3	PLQP0080JA-A						
	R5F562TADDFM	R5F562TADDFM#V3	PLQP0064KB-A						
	R5F562TADDFK	R5F562TADDFK#V3	PLQP0064GA-A						
	R5F562T7DDFH	R5F562T7DDFH#V3	PLQP0112JA-A	128 Kbytes	8 Kbytes	8 Kbytes			
	R5F562T7DDFP	R5F562T7DDFP#V3	PLQP0100KB-A						
	R5F562T7DDFF	R5F562T7DDFF#V3	PLQP0080JA-A						
	R5F562T7DDFM	R5F562T7DDFM#V3	PLQP0064KB-A						
	R5F562T7DDFK	R5F562T7DDFK#V3	PLQP0064GA-A						
	R5F562T6DDFF	R5F562T6DDFF#V3	PLQP0080JA-A	64 Kbytes	8 Kbytes				
	R5F562T6DDFM	R5F562T6DDFM#V3	PLQP0064KB-A						
	R5F562T6DDFK	R5F562T6DDFK#V3	PLQP0064GA-A						
	R5F562TAEDFH	R5F562TAEDFH#V3	PLQP0112JA-A	256 Kbytes	16 Kbytes	32 Kbytes	2.7 to 3.6 V		
	R5F562TAEDFP	R5F562TAEDFP#V3	PLQP0100KB-A						
	R5F562TAEDFF	R5F562TAEDFF#V3	PLQP0080JA-A						
	R5F562TAEDFM	R5F562TAEDFM#V3	PLQP0064KB-A						
	R5F562TAEDFK	R5F562TAEDFK#V3	PLQP0064GA-A						

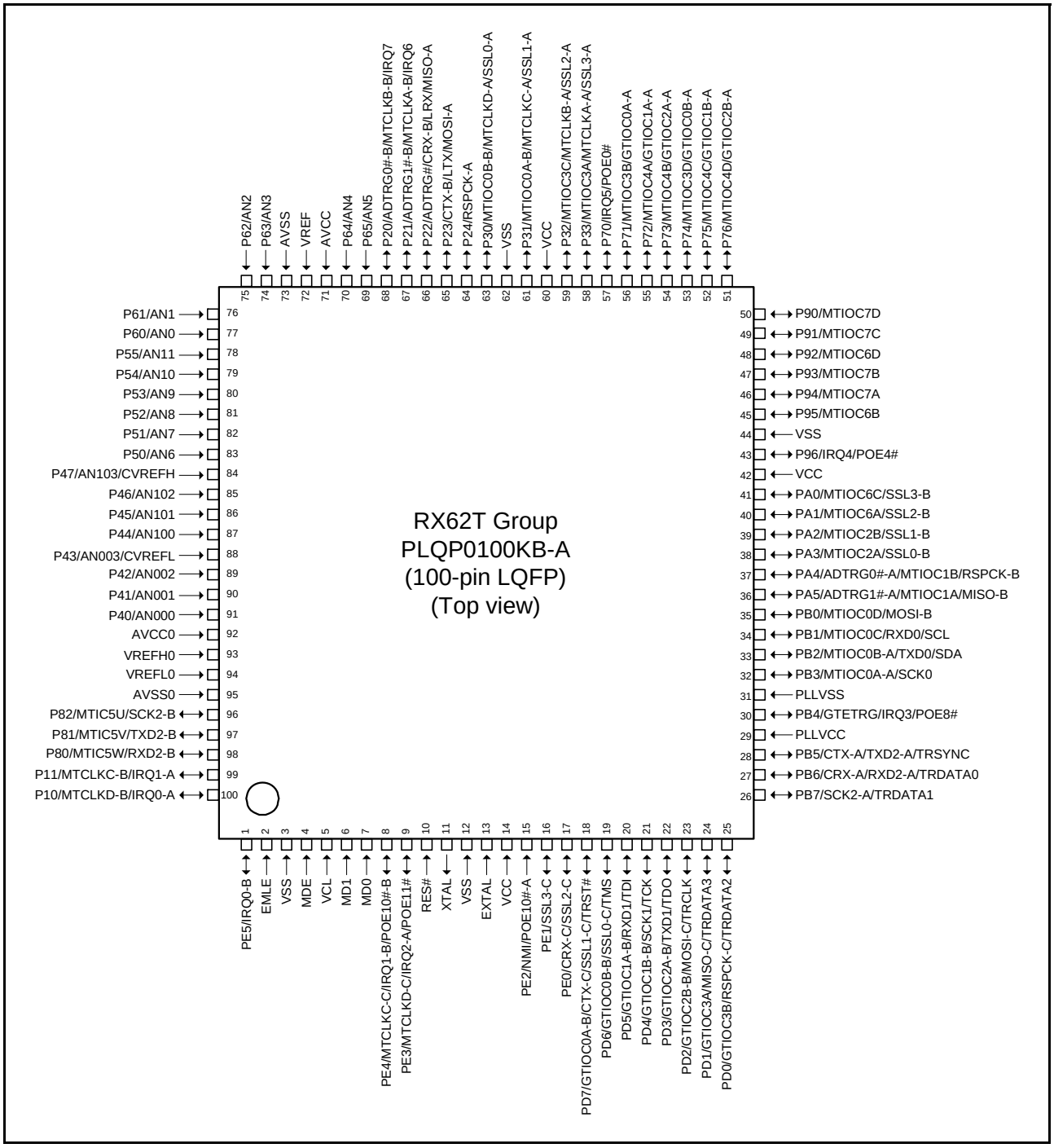


Figure 1.4 Pin Assignment of the 100-Pin LQFP

Table 1.6 List of Pins and Pin Functions (80-Pin LQFP) (2 / 3)

Pin No. (80-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communi-cation	Interrupt	POE	Debugging
42		P75		MTIOC4C/ GTIOC1B-A				
43		P74		MTIOC3D/ GTIOC0B-A				
44		P73		MTIOC4B/ GTIOC2A-A				
45		P72		MTIOC4A/ GTIOC1A-A				
46		P71		MTIOC3B/ GTIOC0A-A				
47		P70				IRQ5	POE0#	
48		P33		MTIOC3A/ MTCLKA-A	SSL3-A			
49		P32		MTIOC3C/ MTCLKB-A	SSL2-A			
50	VCC							
51		P31		MTIOC0A-B/ MTCLKC-A	SSL1-A			
52	VSS							
53		P30		MTIOC0B-B/ MTCLKD-A	SSL0-A			
54		P24			RSPCK-A			
55		P23			CTX-B/ LTX/ MOSI-A			
56		P22	ADTRG#		CRX-B/ LRX/ MISO-A			
57		P21	ADTRG1#-B	MTCLKA-B		IRQ6		
58		P20	ADTRG0#-B	MTCLKB-B		IRQ7		
59	AVCC							
60	AVSS							
61		P63	AN3					
62		P62	AN2					
63		P61	AN1					
64		P60	AN0					
65		P47	AN103/ CVREFH					
66		P46	AN102					
67		P45	AN101					
68		P44	AN100					
69		P43	AN003/ CVREFL					
70		P42	AN002					
71		P41	AN001					
72		P40	AN000					
73	AVCC0							
74	VREFH0							
75	VREFL0							

Table 1.9 Pin Functions (3 / 4)

Classifications	Pin Name	I/O	Description
Serial communications interface (SCIb)	TXD0, TXD1, TXD2-A/TXD2-B	Output	Output pins for data transmission. The TXD2-B pin is not included in the 80-/64-pin versions.
	RXD0, RXD1, RXD2-A/ RXD2-B	Input	Input pins for data reception. The RXD2-B pin is not included in the 80-/64-pin versions.
	SCK0, SCK1, SCK2-A/ SCK2-B	I/O	Input/output pins for clock signals. The SCK2-B pin is not included in the 80-/64-pin versions.
I^2C bus interface (RIIC)	SCL	I/O	Input/output pin for I^2C bus interface clocks. Bus can be directly driven by the NMOS open drain output.
	SDA	I/O	Input/output pin for I^2C bus interface data. Bus can be directly driven by the NMOS open drain output.
CAN module (CAN) (as an optional function)	CRX-A/CRX-B/CRX-C	Input	Input pin for the CAN. The CRX-C pin is not included in the 64-pin version.
	CTX-A/CTX-B/CTX-C	Output	Output pin for the CAN. The CTX-C pin is not included in the 64-pin version.
LIN module (LIN)	LRX	Input	Input pin for the LIN.
	LTX	Output	Output pin for the LIN.
Serial peripheral interface (RSPI)	RSPCK-A/RSPCK-B/ RSPCK-C	I/O	Clock input/output pin for the RSPI. The RSPCK-C pin is not included in the 80-/64-pin versions.
	MOSI-A/MOSI-B/MOSI-C	I/O	Inputs or outputs data output from the master for the RSPI. The MOSI-C pin is not included in the 80-/64-pin versions.
	MISO-A/MISO-B/MISO-C	I/O	Inputs or outputs data output from the slave for the RSPI. The MISO-C pin is not included in the 80-/64-pin versions.
	SSL0-A/SSL0-B/SSL0-C	I/O	Select the slave for the RSPI. The SSL0-C/SSL1-C/SSL2-C/ SSL3-C pin is not included in the 80-/64-pin versions.
	SSL1-A/SSL1-B/SSL1-C SSL2-A/SSL2-B/SSL2-C SSL3-A/SSL3-B/SSL3-C	Output	
A/D converter	AN000 to AN003 AN100 to AN103	Input	Input pins for the analog signals to be processed by the 12-bit A/D converter.
	AN0 to AN11	Input	Input pins for the analog signals to be processed by the 10-bit A/D converter. The AN4 to AN11 pins are not included in the 80-pin version. Not included in the 64-pin version.
	ADTRG0#-A/ADTRG0#-B ADTRG1#-A/ADTRG1#-B ADTRG#	Input	Input pins for the external trigger signals that start the A/D conversion. The ADTRG0#-B/ADTRG1#-B/ADTRG# pin is not included in the 64-pin version.
	CVREFH	Input	Input pin for the high-level reference voltage to the comparator
	CVREFL	Input	Input pin for the low-level reference voltage to the comparator
Analog power supply	AVCC0	Input	Analog power supply pin for the 12-bit A/D converter. When the A/D converter is not in use, connect this pin to the system power supply.
	AVSS0	Input	Ground pin for the 12-bit A/D converter. Connect this pin to the system power supply (0 V).
	VREFH0	Input	Reference power supply pin for the 12-bit A/D converter. When the 12-bit A/D converter is not in use, connect this pin to the system power supply.
	VREFL0	Input	Ground pin of the reference power supply pin for the 12-bit A/D converter. When the 12-bit A/D converter is not in use, connect this pin to the system power supply (0 V).
	AVCC	Input	Analog power supply pin for the 10-bit A/D converter. When the A/D converter is not in use, connect this pin to the system power supply. Not included in the 64-pin version.
	AVSS	Input	Ground pin for the 10-bit A/D converter. Connect this pin to the system power supply (0 V). Not included in the 64-pin version.
	VREF	Input	Reference power supply pin for the 10-bit A/D converter. When the 10-bit A/D converter is not in use, connect this pin to the system power supply. Not included in the 80-/64-pin versions.

2. CPU

The RX CPU has sixteen general-purpose registers, nine control registers, and one accumulator used for DSP instructions.

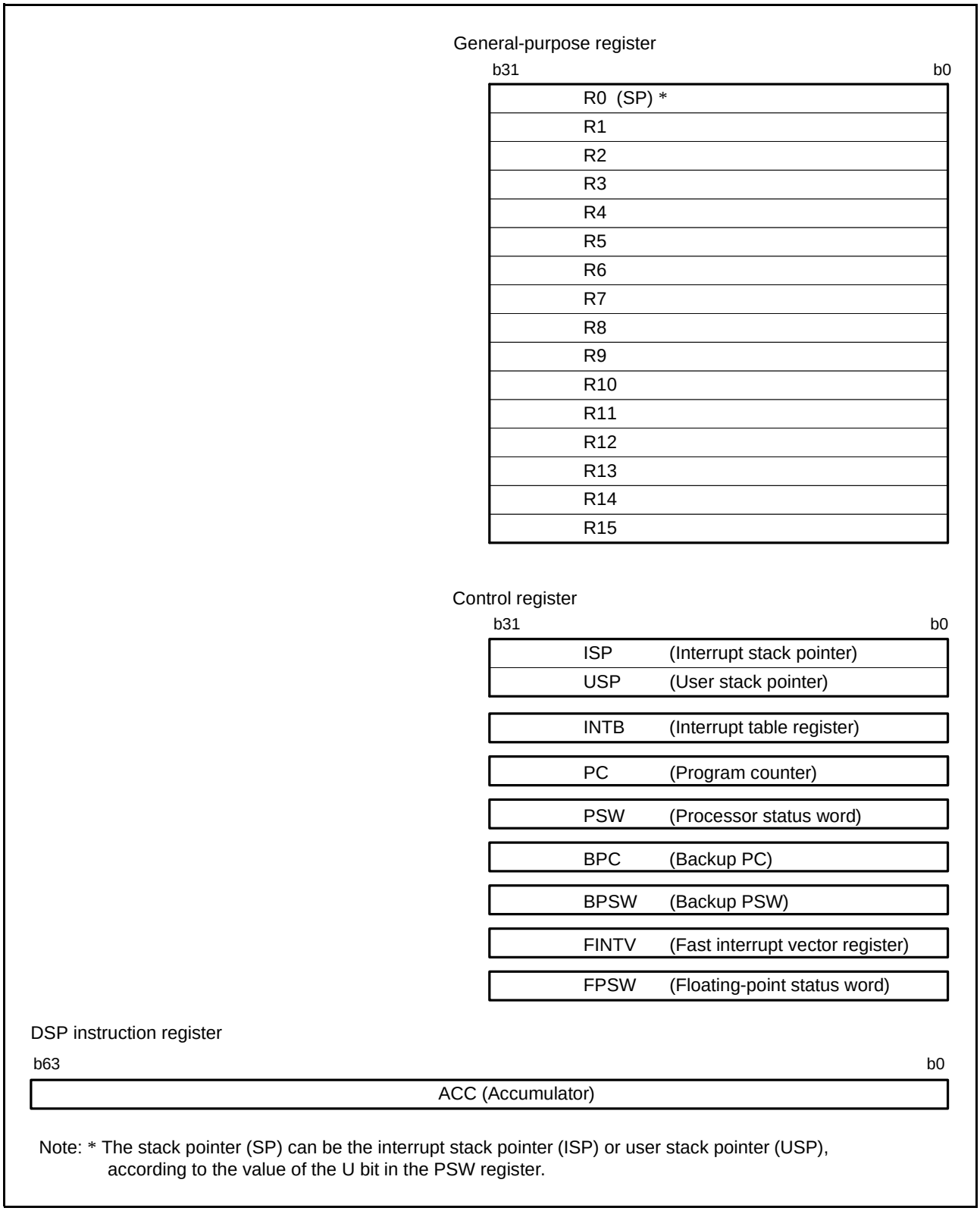


Figure 2.1 Register Set of the CPU

4.1 I/O Register Addresses (Address Order)

Table 4.1 List of I/O Registers (Address Order) (1 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0008 0000h	SYSTEM	Mode monitor register	MDMONR	16	16	3 ICLK
0008 0002h	SYSTEM	Mode status register	MDSR	16	16	3 ICLK
0008 0006h	SYSTEM	System control register 0	SYSCR0	16	16	3 ICLK
0008 0008h	SYSTEM	System control register 1	SYSCR1	16	16	3 ICLK
0008 000Ch	SYSTEM	Standby control register	SBYCR	16	16	3 ICLK
0008 0010h	SYSTEM	Module stop control register A	MSTPCRA	32	32	3 ICLK
0008 0014h	SYSTEM	Module stop control register B	MSTPCRB	32	32	3 ICLK
0008 0018h	SYSTEM	Module stop control register C	MSTPCRC	32	32	3 ICLK
0008 0020h	SYSTEM	System clock control register	SCKCR	32	32	3 ICLK
0008 0040h	SYSTEM	Oscillation stop detection control register	OSTDCR	16	16	3 ICLK
0008 1300h	BSC	Bus error status clear register	BERCLR	8	8	2 ICLK
0008 1304h	BSC	Bus error monitoring enable register	BEREN	8	8	2 ICLK
0008 1308h	BSC	Bus error status register 1	BERSR1	8	8	2 ICLK
0008 130Ah	BSC	Bus error status register 2	BERSR2	16	16	2 ICLK
0008 2400h	DTC	DTC control register	DTCCR	8	8	2 ICLK
0008 2404h	DTC	DTC vector base register	DTCVBR	32	32	2 ICLK
0008 2408h	DTC	DTC address mode register	DTCADMOD	8	8	2 ICLK
0008 240Ch	DTC	DTC module start register	DTCST	8	8	2 ICLK
0008 240Eh	DTC	DTC status register	DTCSTS	16	16	2 ICLK
0008 6400h	MPU	Region 0 start page-number register	RSPAGE0	32	32	1 ICLK
0008 6404h	MPU	Region 0 end page-number register	REPAGE0	32	32	1 ICLK
0008 6408h	MPU	Region 1 start page-number register	RSPAGE1	32	32	1 ICLK
0008 640Ch	MPU	Region 1 end page-number register	REPAGE1	32	32	1 ICLK
0008 6410h	MPU	Region 2 start page-number register	RSPAGE2	32	32	1 ICLK
0008 6414h	MPU	Region 2 end page-number register	REPAGE2	32	32	1 ICLK
0008 6418h	MPU	Region 3 start page-number register	RSPAGE3	32	32	1 ICLK
0008 641Ch	MPU	Region 3 end page-number register	REPAGE3	32	32	1 ICLK
0008 6420h	MPU	Region 4 start page-number register	RSPAGE4	32	32	1 ICLK
0008 6424h	MPU	Region 4 end page-number register	REPAGE4	32	32	1 ICLK
0008 6428h	MPU	Region 5 start page-number register	RSPAGE5	32	32	1 ICLK
0008 642Ch	MPU	Region 5 end page-number register	REPAGE5	32	32	1 ICLK
0008 6430h	MPU	Region 6 start page-number register	RSPAGE6	32	32	1 ICLK
0008 6434h	MPU	Region 6 end page-number register	REPAGE6	32	32	1 ICLK
0008 6438h	MPU	Region 7 start page-number register	RSPAGE7	32	32	1 ICLK
0008 643Ch	MPU	Region 7 end page-number register	REPAGE7	32	32	1 ICLK
0008 6500h	MPU	Memory-protection enable register	MPEN	32	32	1 ICLK
0008 6504h	MPU	Background access control register	MPBAC	32	32	1 ICLK
0008 6508h	MPU	Memory-protection error status-clearing register	MPECLR	32	32	1 ICLK
0008 650Ch	MPU	Memory-protection error status register	MPESTS	32	32	1 ICLK
0008 6514h	MPU	Data memory-protection error address register	MPDEA	32	32	1 ICLK
0008 6520h	MPU	Region search address register	MPSA	32	32	1 ICLK
0008 6524h	MPU	Region search operation register	MPOPS	16	16	1 ICLK

Table 4.1 List of I/O Registers (Address Order) (11 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0008 8383h	RSPI	RSPI status register	SPSR	8	8	2, 3 PCLK*3
0008 8384h	RSPI	RSPI data register	SPDR	16, 32	16, 32	2, 3 PCLK*3
0008 8388h	RSPI	RSPI sequence control register	SPSCR	8	8	2, 3 PCLK*3
0008 8389h	RSPI	RSPI sequence status register	SPSSR	8	8	2, 3 PCLK*3
0008 838Ah	RSPI	RSPI bit rate register	SPBR	8	8	2, 3 PCLK*3
0008 838Bh	RSPI	RSPI data control register	SPDCR	8	8	2, 3 PCLK*3
0008 838Ch	RSPI	RSPI clock delay register	SPCKD	8	8	2, 3 PCLK*3
0008 838Dh	RSPI	RSPI slave select negation delay register	SSLND	8	8	2, 3 PCLK*3
0008 838Eh	RSPI	RSPI next-access delay register	SPND	8	8	2, 3 PCLK*3
0008 838Fh	RSPI	RSPI control register 2	SPCR2	8	8	2, 3 PCLK*3
0008 8390h	RSPI	RSPI command register 0	SPCMD0	16	16	2, 3 PCLK*3
0008 8392h	RSPI	RSPI command register 1	SPCMD1	16	16	2, 3 PCLK*3
0008 8394h	RSPI	RSPI command register 2	SPCMD2	16	16	2, 3 PCLK*3
0008 8396h	RSPI	RSPI command register 3	SPCMD3	16	16	2, 3 PCLK*3
0008 8398h	RSPI	RSPI command register 4	SPCMD4	16	16	2, 3 PCLK*3
0008 839Ah	RSPI	RSPI command register 5	SPCMD5	16	16	2, 3 PCLK*3
0008 839Ch	RSPI	RSPI command register 6	SPCMD6	16	16	2, 3 PCLK*3
0008 839Eh	RSPI	RSPI command register 7	SPCMD7	16	16	2, 3 PCLK*3
0008 9000h	S12AD0	A/D control register	ADCSR	8	8	2, 3 PCLK*3
0008 9004h	S12AD0	A/D channel select register	ADANS	16	16	2, 3 PCLK*3
0008 900Ah	S12AD0	A/D programmable gain amplifier register	ADPG	16	16	2, 3 PCLK*3
0008 900Eh	S12AD0	A/D control extended register	ADCER	16	16	2, 3 PCLK*3
0008 9010h	S12AD0	A/D start trigger select register	ADSTRGR	16	16	2, 3 PCLK*3
0008 9012h	S12AD	Comparator operating mode select register 0	ADCMPMD0	16	16	2, 3 PCLK*3
0008 9014h	S12AD	Comparator operating mode select register 1	ADCMPMD1	16	16	2, 3 PCLK*3
0008 9016h	S12AD	Comparator filter mode register 0	ADCMPNR0	16	16	2, 3 PCLK*3
0008 9018h	S12AD	Comparator filter mode register 1	ADCMPNR1	16	16	2, 3 PCLK*3
0008 901Ah	S12AD	Comparator detection flag register	ADCMPFR	8	8	2, 3 PCLK*3
0008 901Ch	S12AD	Comparator interrupt select register	ADCMPSEL	16	16	2, 3 PCLK*3
0008 901Eh	S12AD0	A/D data register Diag	ADRD	16	16	2, 3 PCLK*3
0008 9020h	S12AD0	A/D data register 0A	ADDR0A	16	16	2, 3 PCLK*3
0008 9022h	S12AD0	A/D data register 1	ADDR1	16	16	2, 3 PCLK*3
0008 9024h	S12AD0	A/D data register 2	ADDR2	16	16	2, 3 PCLK*3
0008 9026h	S12AD0	A/D data register 3	ADDR3	16	16	2, 3 PCLK*3
0008 9030h	S12AD0	A/D data register 0B	ADDR0B	16	16	2, 3 PCLK*3
0008 9060h	S12AD0	A/D sampling state register	ADSSTR	8	8	2, 3 PCLK*3
0008 9080h	S12AD1	A/D control register	ADCSR	8	8	2, 3 PCLK*3
0008 9084h	S12AD1	A/D channel select register	ADANS	16	16	2, 3 PCLK*3
0008 908Ah	S12AD1	A/D programmable gain amplifier register	ADPG	16	16	2, 3 PCLK*3
0008 908Eh	S12AD1	A/D control extended register	ADCER	16	16	2, 3 PCLK*3
0008 9090h	S12AD1	A/D start trigger select register	ADSTRGR	16	16	2, 3 PCLK*3
0008 909Eh	S12AD1	A/D data register Diag	ADRD	16	16	2, 3 PCLK*3
0008 90A0h	S12AD1	A/D data register 0A	ADDR0A	16	16	2, 3 PCLK*3
0008 90A2h	S12AD1	A/D data register 1	ADDR1	16	16	2, 3 PCLK*3

Table 4.1 List of I/O Registers (Address Order) (13 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0008 C065h	PORT5	Input buffer control register	ICR	8	8	2, 3 PCLK*3
0008 C066h	PORT6	Input buffer control register	ICR	8	8	2, 3 PCLK*3
0008 C067h	PORT7	Input buffer control register	ICR	8	8	2, 3 PCLK*3
0008 C068h	PORT8	Input buffer control register	ICR	8	8	2, 3 PCLK*3
0008 C069h	PORT9	Input buffer control register	ICR	8	8	2, 3 PCLK*3
0008 C06Ah	PORTA	Input buffer control register	ICR	8	8	2, 3 PCLK*3
0008 C06Bh	PORTB	Input buffer control register	ICR	8	8	2, 3 PCLK*3
0008 C06Dh	PORTD	Input buffer control register	ICR	8	8	2, 3 PCLK*3
0008 C06Eh	PORTE	Input buffer control register	ICR	8	8	2, 3 PCLK*3
0008 C070h	PORTG	Input buffer control register	ICR*1	8	8	2, 3 PCLK*3
0008 C108h	IOPORT	Port function register 8	PF8IRQ	8	8	2, 3 PCLK*3
0008 C109h	IOPORT	Port function register 9	PF9IRQ	8	8	2, 3 PCLK*3
0008 C10Ah	IOPORT	Port function register A	PFAADC	8	8	2, 3 PCLK*3
0008 C10Ch	IOPORT	Port function register C	PFCMTU	8	8	2, 3 PCLK*3
0008 C10Dh	IOPORT	Port function register D	PFDGPT	8	8	2, 3 PCLK*3
0008 C10Fh	IOPORT	Port function register F	PFFSCI	8	8	2, 3 PCLK*3
0008 C110h	IOPORT	Port function register G	PFGSPI	8	8	2, 3 PCLK*3
0008 C111h	IOPORT	Port function register H	PFHSPI	8	8	2, 3 PCLK*3
0008 C113h	IOPORT	Port function register J	PFJCAN	8	8	2, 3 PCLK*3
0008 C114h	IOPORT	Port function register K	PFKLIN	8	8	2, 3 PCLK*3
0008 C116h	IOPORT	Port function register M	PFMPOE	8	8	2, 3 PCLK*3
0008 C117h	IOPORT	Port function register N	PFNPOE	8	8	2, 3 PCLK*3
0008 C280h	SYSTEM	Deep standby control register	DPSBYCR	8	8	4, 5 PCLK*3
0008 C281h	SYSTEM	Deep standby wait control register	DPSWCR	8	8	4, 5 PCLK*3
0008 C282h	SYSTEM	Deep standby interrupt enable register	DPSIER	8	8	4, 5 PCLK*3
0008 C283h	SYSTEM	Deep standby interrupt flag register	DPSIFR	8	8	4, 5 PCLK*3
0008 C284h	SYSTEM	Deep standby interrupt edge register	DPSIEGR	8	8	4, 5 PCLK*3
0008 C285h	SYSTEM	Reset status register	RSTSR	8	8	4, 5 PCLK*3
0008 C289h	FLASH	Flash write erase protection register	FWEPROR	8	8	4, 5 PCLK*3
0008 C28Ch	SYSTEM	Key code register for low-voltage detection control register	LVDKEYR	8	8	4, 5 PCLK*3
0008 C28Dh	SYSTEM	Voltage detection control register	LVDCR	8	8	4, 5 PCLK*3
0008 C290h	SYSTEM	Deep standby backup register 0	DPSBKR0	8	8	4, 5 PCLK*3
0008 C291h	SYSTEM	Deep standby backup register 1	DPSBKR1	8	8	4, 5 PCLK*3
0008 C292h	SYSTEM	Deep standby backup register 2	DPSBKR2	8	8	4, 5 PCLK*3
0008 C293h	SYSTEM	Deep standby backup register 3	DPSBKR3	8	8	4, 5 PCLK*3
0008 C294h	SYSTEM	Deep standby backup register 4	DPSBKR4	8	8	4, 5 PCLK*3
0008 C295h	SYSTEM	Deep standby backup register 5	DPSBKR5	8	8	4, 5 PCLK*3
0008 C296h	SYSTEM	Deep standby backup register 6	DPSBKR6	8	8	4, 5 PCLK*3
0008 C297h	SYSTEM	Deep standby backup register 7	DPSBKR7	8	8	4, 5 PCLK*3
0008 C298h	SYSTEM	Deep standby backup register 8	DPSBKR8	8	8	4, 5 PCLK*3
0008 C299h	SYSTEM	Deep standby backup register 9	DPSBKR9	8	8	4, 5 PCLK*3
0008 C29Ah	SYSTEM	Deep standby backup register 10	DPSBKR10	8	8	4, 5 PCLK*3
0008 C29Bh	SYSTEM	Deep standby backup register 11	DPSBKR11	8	8	4, 5 PCLK*3

Table 4.2 List of I/O Registers (Bit Order) (23 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
GPT	GTBDR	BD33	BD32	BD31	BD30	BD23	BD22	BD21	BD20
		BD13	BD12	BD11	BD10	BD03	BD02	BD01	BD00
GPT	GTSWP	—	—	—	—	—	—	—	—
		—	—	—	—	SWP3	SWP2	SWP1	SWP0
GPT	LCCR	LPSC[1:0]		TPSC[1:0]		LCNTAT		LCTO[2:0]	
		—	LCINTO	LCINTD	LCINTC	—	LCNTS	LCNTCR	LCNTE
GPT	LCST	—	—	—	—	—	—	—	—
		—	—	—	—	—	LISO	LISD	LISC
GPT	LCNTA								
GPT	LCNT00								
GPT	LCNT01								
GPT	LCNT02								
GPT	LCNT03								
GPT	LCNT04								
GPT	LCNT05								
GPT	LCNT06								
GPT	LCNT07								
GPT	LCNT08								
GPT	LCNT09								
GPT	LCNT10								
GPT	LCNT11								
GPT	LCNT12								
GPT	LCNT13								
GPT	LCNT14								
GPT	LCNT15								
GPT	LCNTDU								
GPT	LCNTDL								
GPT0	GTIOR	OBHLD	OBDFLT			GTIOB[5:0]			
		OAHLD	OADFLT			GTIOA[5:0]			
GPT0	GTINTAD	ADTRBDEN	ADTRBUEN	ADTRADEN	ADTRAUEN	EINT	—	—	—
		GTINTPR[1:0]		GTINTF	GTINTE	GTINTD	GTINTC	GTINTB	GTINTA

5.2 DC Characteristics

Table 5.2 DC Characteristics (1) (1 / 3)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	CAN input pin IRQ input pin MTU3 input pin POE3 input pin SCI input pin A/D trigger input pin NMI input pin GPT input pin LIN input pin RES#	V_{IH}	VCC×0.8	-	VCC+0.3	V	
		V_{IL}	-0.3	-	VCC×0.2		
		ΔV_T	VCC ×0.06	-	-		
	RIIC input pin (IICBus)	V_{IH}	VCC×0.7	-	VCC+0.3		
		V_{IL}	-0.3	-	VCC×0.3		
		ΔV_T	VCC ×0.05	-	-		
	Port 4*1 (also usable as an analog port)	V_{IH}	AVCC0 ×0.8	-	AVCC0 +0.3		
		V_{IL}	- 0.3	-	AVCC0 ×0.2		
		ΔV_T	AVCC0 ×0.06	-	-		
	Ports 5 and 6*1 (also usable as analog ports)	V_{IH}	AVCC ×0.8	-	AVCC +0.3		
		V_{IL}	-0.3	-	AVCC ×0.2		
		ΔV_T	AVCC ×0.06	-	-		
	Ports 1 to 3*1 Ports 7 to B*1 Ports D, E, and G*1	V_{IH}	VCC×0.8	-	VCC+0.3		
		V_{IL}	-0.3	-	VCC×0.2		
		ΔV_T	VCC ×0.06	-	-		
Input high voltage (except Schmitt trigger input pin)	MD pin, EMLE	V_{IH}	VCC×0.9	-	VCC+0.3	V	
	EXTAL RSPI input pin		VCC×0.8		VCC+0.3		
	RIIC input pin (SMBus)		2.1		VCC+0.3		Conditions 1 and 2
Input low voltage (except Schmitt trigger input pin)	MD pin, EMLE	V_{IL}	-0.3	-	VCC×0.1	V	
	EXTAL RSPI input pin		-0.3	-	VCC×0.2		
	RIIC input pin (SMBus)		-0.3	-	0.8		Conditions 1 and 2

Table 5.2 DC Characteristics (1) (3 / 3)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input capacitance	All input pins (except for ports PB1 and PB2)	C_{in}	-	-	15	pF	V_{in} = 0 V, f = 1 MHz, T_a = 25°C
	Ports PB1 and PB2		-	-	30		

Note 1. This includes the multiplexed input pins, except in cases where port pins PB1 and PB2 are used as RIIC input pins or port pins P22 to P24, P30, PA3 to PA5, PB0, PD0 to PD2, or PD6 are used as RSPI input pins.

Table 5.3 DC Characteristics (2)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Supply current*1	In operation	Max.*2	I_{CC}*3	-	-	70	mA	ICLK = 100 MHz PCLK = 50 MHz
		Normal*4		-	35	-		
		Increased by BGO operation*5		-	15	-		
	Sleep				22	60		
	All-module-clock-stop mode*6				14	28		
	Standby mode	Software standby mode		-	0.10	3	mA	
		Deep software standby mode		-	20	60	µA	
Analog power supply current	During 12-bit A/D conversion (when a sample-and-hold circuit is in use; per unit)		AI_{CC0}	-	3	5	mA	
	During 12-bit A/D conversion (when a sample-and-hold circuit is not in use; per unit)			-	3	5	mA	
	Programmable gain amp (per channel)			-	1	2	mA	
	Window comparator (1 channel)				0.5	1	mA	
	Window comparator (6 channels)			-	1	2	mA	
	During 12-bit A/D conversion (per unit)			-	60	90	µA	
	During 10-bit A/D conversion (per unit)		AI_{CC}	-	0.9	2	mA	
	Waiting for 10-bit A/D conversion (all units)			-	0.3	3	µA	
Reference power supply current	During 12-bit A/D conversion (per unit)		AI_{REFH0}	-	1.6	3	mA	
	Waiting for 12-bit A/D conversion (all units)			-	1.6	3	mA	
	During 10-bit A/D conversion (per unit)		AI_{REF}	-	0.1	1	mA	
	Waiting for 10-bit A/D conversion (all units)			-	0.1	3	µA	
VCC rising gradient			SV_{CC}	-	-	20	ms/V	

Note 1. Supply current values are with all output pins unloaded.
Note 2. Measured with clocks supplied to the peripheral functions. This does not include the BGO operation.
Note 3. I_{CC} depends on f (ICLK) as follows. (ICLK: PCLK = 8:4)
ICC max. = 0.54 x f + 16 (max.)
ICC max. = 0.3 x f + 5 (normal operation)
ICC max. = 0.44 x f + 16 (sleep mode)
Note 4. Measured with clocks not supplied to the peripheral functions. This does not include the BGO operation.
Note 5. Incremented if data is written to or erased from the ROM or data flash for data storage during the program execution.
Note 6. The values are for reference.

Table 5.4 Permissible Output Currents

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit
Permissible output low current (average value per pin)	I_{OL}	-	-	2.0*1	mA
Permissible output low current (max. value per pin)	I_{OL}	-	-	4.0*1	mA
Permissible output low current (total)	ΣI_{OL}	-	-	110	mA
Permissible output high current (average value per pin)	$-I_{OH}$	-	-	2.0*1	mA
Permissible output high current (max. value per pin)	$-I_{OH}$	-	-	4.0*1	mA
Permissible output high current (total)	$\Sigma -I_{OH}$	-	-	35	mA

Caution: To protect the LSI's reliability, the output current values should not exceed the permissible output current.

Note 1. I_{OL} = 15 mA (max.)/ $-I_{OH}$ = 5 mA (max.) for P71 to P76 and P90 to P95. Note, however, that up to 6 (112-pin or 100-pin LQFP) or 3 (80-pin or 64-pin LQFP) pins can accept over 2.0-mA I_{OL} / $-I_{OH}$ at the same time.

Table 5.5 Permissible Power Consumption (Only for G Version)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Typ.	Max.	Unit	Test Conditions
Total permissible power consumption*1	Pd	—	325	mW	85°C < Ta ≤ 105°C

Note: • Please contact Renesas Electronics sales office for derating of operation under Ta = +85°C to +105°C. Derating is the systematic reduction of load for improved reliability.

Note 1. The total power consmuption of the whole chip including output current.

5.3 AC Characteristics

Table 5.6 Operation Frequency Value

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item		Symbol	Min.	Typ.	Max.	Unit
Operating frequency	System clock (ICLK)	f	8	-	100	MHz
	Peripheral module clock (PCLK)		8	-	50	

5.3.1 Clock Timing

Table 5.7 Clock Timing

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC
Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Max.	Unit	Test Conditions
Oscillation settling time after reset (crystal)	t_{OSC1}	10	-	ms	Figure 5.1
Oscillation settling time after leaving software standby mode (crystal)	t_{OSC2}	10	-	ms	Figure 5.2
Oscillation settling time after leaving deep software standby mode (crystal)	t_{OSC3}	10	-	ms	Figure 5.3
EXTAL external clock output delay settling time	t_{DEXT}	1	-	ms	Figure 5.1
EXTAL external clock input low pulse width	t_{EXL}	35	-	ns	Figure 5.4
EXTAL external clock input high pulse width	t_{EXH}	35	-	ns	
EXTAL external clock rising time	t_{EXr}	-	5	ns	
EXTAL external clock falling time	t_{EXf}	-	5	ns	
On-chip oscillator (IWDTCLK) oscillation frequency	$f_{IWDTCLK}$	62.5	187.5	kHz	

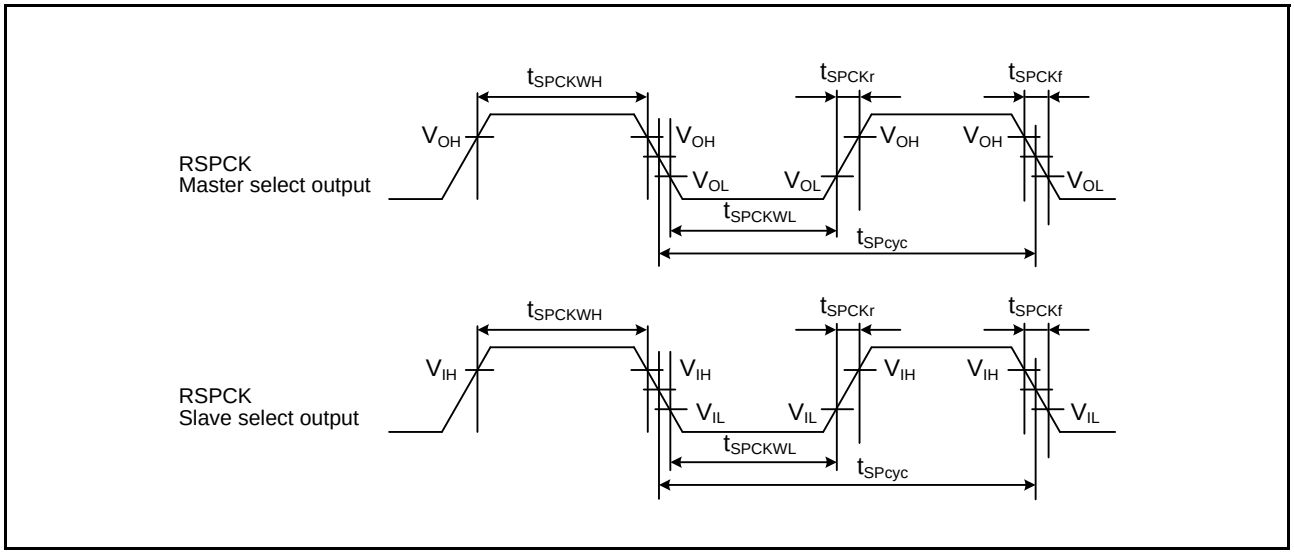


Figure 5.11 RSPI Clock Timing

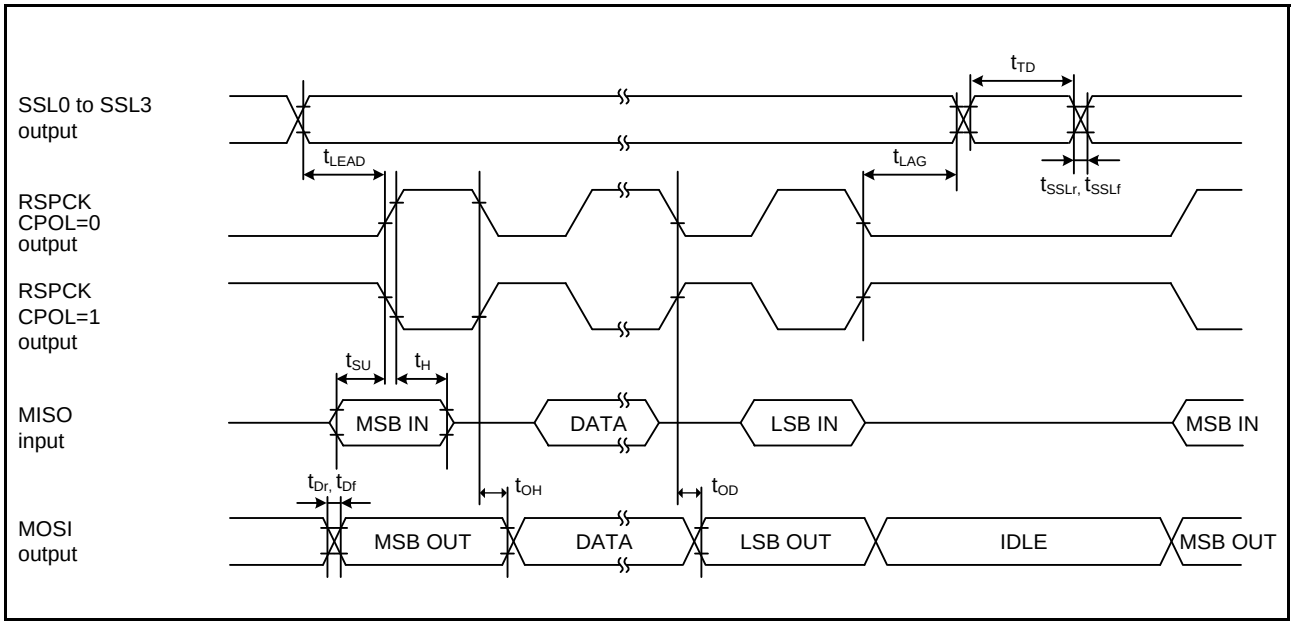


Figure 5.12 RSPI Timing (Master, CPHA = 0)

Table 5.18 Comparator Characteristics

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC
Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Analog input capacitance	Cin	-	-	6	pF	
REFH pin offset voltage	Voff	-	-	5	mV	
REFL pin offset voltage		-	-	5	mV	
REFH input voltage range	Vin	1.7	-	AVcc – 0.3	V	
REFL input voltage range		0.3	-	AVcc – 1.7	V	
REFH reply time	tCR	-	-	1	µs	
REFL reply time	tCF	-	-	1	µs	

5.5 Power-on Reset Circuit, Voltage Detection Circuit Characteristics

Table 5.19 Power-on Reset Circuit, Voltage Detection Circuit Characteristics

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 and 2.

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Power-on reset (POR)	V_{POR}	2.48	2.60	2.72	V	Figure 5.20
	Voltage detection circuit (LVD)	Vdet1	2.68	2.80	2.92		Figure 5.21
		Vdet2	2.98	3.10	3.22		Figure 5.22
Internal reset time		t_{POR}	20	35	50	ms	Figure 5.21 and Figure 5.22
Min. VCC down time*1		t_{VOFF}	200	-	-	us	Figure 5.20 to Figure 5.22
Reply delay time		tdet	-	-	200	us	

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Power-on reset (POR)	V_{POR}	3.70	3.90	4.10	V	Figure 5.20
	Voltage detection circuit (LVD)	Vdet1	3.95	4.15	4.35		Figure 5.21
		Vdet2	4.40	4.60	4.80		Figure 5.22
Internal reset time		t_{POR}	20	35	50	ms	Figure 5.21 and Figure 5.22
Min. VCC down time*1		t_{VOFF}	200	-	-	us	Figure 5.20 to Figure 5.22
Reply delay time		tdet	-	-	200	us	

Note 1. The power-off time indicates the time when VCC is below the minimum value of voltage detection levels V_{POR}, V_{det1}, and V_{det2} for the POR/ LVD.

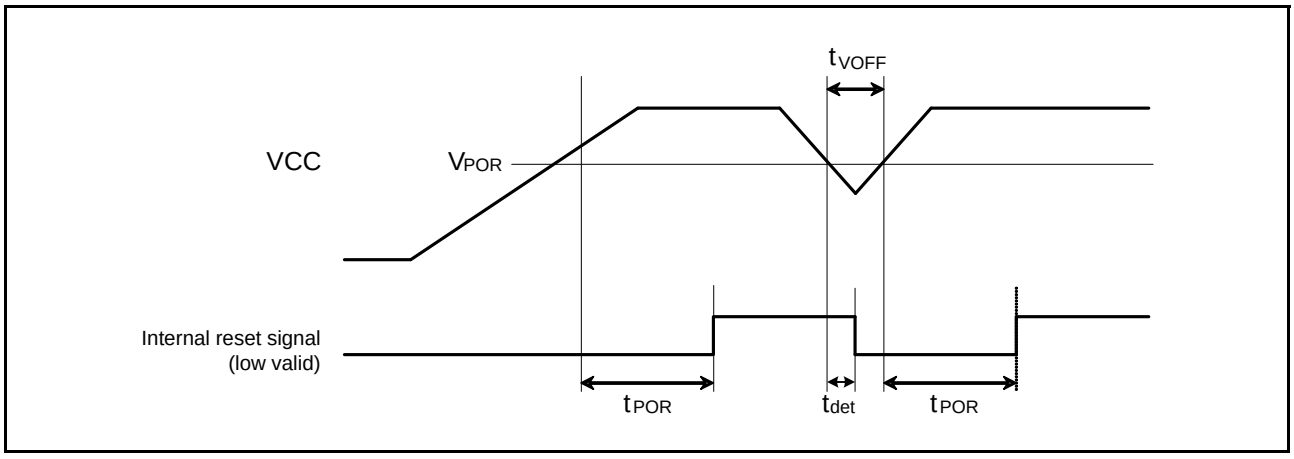
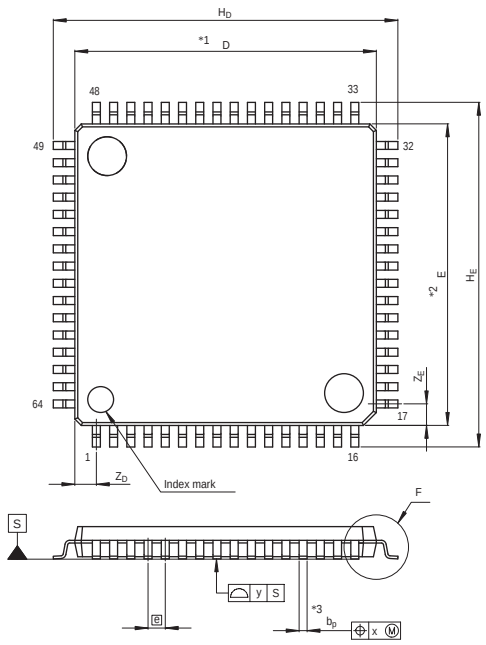
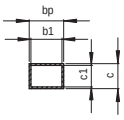


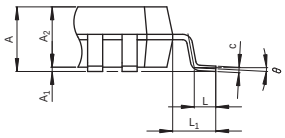
Figure 5.20 Power-on Reset Timing

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP64-14x14-0.80	PLQP0064GA-A	64P6U-A/ —	0.7g





Terminal cross section



Detail F

NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	13.9	14.0	14.1
E	13.9	14.0	14.1
A_2	—	1.4	—
H_D	15.8	16.0	16.2
H_E	15.8	16.0	16.2
A	—	—	1.7
A_1	0	0.1	0.2
b_p	0.32	0.37	0.42
b_1	—	0.35	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.8	—
x	—	—	0.20
y	—	—	0.10
Z_D	—	1.0	—
Z_E	—	1.0	—
L	0.3	0.5	0.7
L_1	—	1.0	—

Figure E 64-Pin LQFP (PLQP0064GA-A) Package Dimensions

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

   Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

   — The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.